Leah Markowitz

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Filing Date

Attorney Docket Numb r

**First Named Inventor** 

Application Number

**DECLARATION FOR UTILITY OR** 

PATENT APPLICATION

(37 CFR 1.63)

Declaration

Submitted after Initial

**DESIGN** 

OR

Declaration

Submitted

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with Initial OR Filing	Filing (sur (37 CFR 1	charge	Group Art Unit		ur							
g	required)	1.10(0))	Examir	Examiner Name		known						
As a below named Inventor, I hereby declare that:												
My residence, mailing address, and citizenship are as stated below next to my name.												
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:												
TRANSPARENT INTER-METAL DIELECTRIC STACK FOR CMOS IMAGE SENSORS												
SENSURS												
(Title of the Invention)												
the specification of which ☑ is attached hereto												
OR  was filed on (MM/												
was filed on (MM/DD/YYYY) as United States Application Number or PCT International												
Application Number and was amended on (MM/DD/YYYY) (if applicable).												
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.												
l acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-												
in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.												
I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent, inventor's or plant breeders rights certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent, inventor's or plant breeder's certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.												
Prior Foreign Application Number(s)	Country	Foreign Filin		Priority			by Attached?					
	Country	(IVIIVI/DD/1	111)	Not Claim	ieu	YES	NO NO					
N/A												
Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto:												
I hereby claim the benefit under 35 U.S.C. 119(h) of any United States provisional application(s) listed below.  Application Number(s) Filing Date (MM/DD/YYYY)												
N/A					Additional provisional application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto.							

[Page 1 of 2]

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	DE	CLARATIO	N -	<u> </u>	ility c	r D	esigr	n Pa	aten	t Ap	plic	atio	n			
I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of the application is not designated in the prior United States or PCT international application in the manner provided by the first paragraph of 31 U.S.C. 112. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.												not 12.				
U.S. Parent Application or PCT Parent Number							Parent Filing Date F (MM/DD/YYYY)					Parent Patent Number (if applicable)				
N/A																
Additional U.S.	or PCT	international applic	ation n	umbers	are listed	l on a	suppleme	ental p	oriority (	data she	et PTC	D/SB/02	8 atta	ached h	ereto.	
As a named invento	or. I here	by appoint the foll	lowina	register	ed practiti	ioner(:	s) to pros	ecute	this ar	onlication	n and f	o trans	act a	l husin	ess in 1	the
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N	Name			Registration Number				Name				Registration Number				
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.											are					
Nam of Sole or First Inventor:   A petition has been filed for this unsigned inventor																
Given Name (first and middle (if any)						Family Name or Surname										
		Leah					0			Mari	kowit	z				
Inventor's Signati	ure	Leah 1	Mai	rko	witz		V.	o ſ	,		D	ate	M	2y-1	3, 2	00
Residence: City		Givat Ela	S	tate		_	Count	Country Is		rael	ael Citizer		nship Israe		srael	
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## **DECLARATION**

## ADDITIONAL INVENTOR(S) Supplemental Sheet Page 1 of 1

Name of Additional Joint Inventor, if any:				A petition has been filed for this unsigned inventor							
Given Name (first and middle (if any)				Family Name or Surname							
Roey				Shaviv							
Inventor's Signature	phon	Sh	ini	_			Date	5~1	Ne 508,2003		
Residence: City	Givat Ela	State		Country Israel			Citizenshi	р	Israel		
Mailing Address	P.O. Box 619										
City	Migdal Haemek	State			ZIP	23105	Country		Israel		
Name of Additional	☐ A petition has been filed for this unsigned inventor										
Given Name	(first and middle (it	f any)		Family Name or Surname							
Inventor's Signature							Date				
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City	State ZIP					Country		us			
Name of Additional	Joint Inventor,	☐ A petition has been filed for this unsigned inventor									
Given Name (first and middle (if any)				Family Name or Surname							
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Inventor's Signature							Date				
City		State			Country	us	Citizenship				
Mailing Address											
City		State			ZIP		Country		US		

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